A, W.H, McL & N Docket No._

Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My	y residence,	post office ac	idress and citize	nship are as state	ed below next to my	name.
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are specification	of which is attached hereto unless the follo	wing is checked:			
	was filed on	as United States Application Number or PCT Internationaand was amended on			
	Application Number(if applicable).				
by any amendme	at I have reviewed and understand the content referred to above.				
acknowledge the	e duty to disclose information which is mate	rial to patentability as defir	ned in Title 37, Code of Federal R	egulations, § 1.5	
inventor's certific ing date before th	reign priority benefits under Title 35, Unite cate listed below and have also identified be nat of the application on which priority is cl	low any foreign application			
<i>a</i>	HEI,11 - 370328	Japan	27/12/1999	Priority Claim	
(List prior foreign	(Number)	(Country)	(Day/Month/Year Filed)		
applications. See note A	(Number)	(Country)	(Day/Month/Year Filed)	_ O Yes O N	
on back of this page)	(Number)	(Country)	(Day/Month/Year Filed)		
	(Number)	(Country)	(Day/Month/Year Filed)	_ 0 165 0 14	
		d list for additional prior f	foreign applications		
See note B on b	ack of this page)				
	e benefit under Title 35, United States Code		States provisional application(s) I	isted below.	
	e benefit under Title 35, United States Code	e, § 119(e) of any United S		isted below.	
	(Application Number)	e, § 119(e) of any United S	(Filing Date)	isted below.	
	e benefit under Title 35, United States Code	e, § 119(e) of any United S		isted below. 	
I hereby claim the subject matter of the first paragrapity as defined in '	(Application Number)	e, § 119(e) of any United States, § 120 of any United States disclosed in the prior United States which became available	(Filing Date) (Filing Date) tes application(s) listed below an ited States application in the man isclose information which is mate	d, insofar as the ner provided by erial to patentabi	
I hereby claim th subject matter of the first paragrap ity as defined in '	(Application Number) (Application Number) (Application Number) e benefit under Title 35, United States Code each of the claims of this application is not h of Title 35, United States Code, § 112, I a Title 37, Code of Federal Regulations, § 1.5 or PCT international filing date of the applications.	e, § 119(e) of any United States, § 120 of any United States disclosed in the prior United States which became available	(Filing Date) (Filing Date) tes application(s) listed below an ited States application in the man isclose information which is mate	d, insofar as the ner provided by erial to patentabi	

I nereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

James E. Armstrong, III, Reg. No. 18,366; William F. Westerman, Reg. No. 29,988; Ken-Ichi Hattori, Reg. No. 32,861; Le-Nhung McLeland, Reg. No. 31,541; Ronald F. Naughton, Reg. No. 24,616; John R. Pegan, Reg. No. 18,069; William G. Kratz, Jr., Reg. No. 22,631; Albert Tockman, Reg. No. 19,722; Mel R. Quintos, Reg. No. 31,898; Donald W. Hanson, Reg. No. 27,133; Stephen G. Adrian, Reg. No. 32,878; William L. Brooks, Reg. No. 34,129; John F. Carney, Reg. No. 20,276; Edward F. Welsh, Reg. No. 22,455; Patrick D. Muir, Reg. No. 37,403; Gay A. Spahn, Reg. No. 34,978; John P. Kong, Reg. No. 40,054; and Luke A. Kilyk, Reg. No. 33,251.

Please direct all communications to the following address:

ARMSTRONG, WESTERMAN, HATTORI, McLELAND & NAUGHTON 1725 K Street, N.W., Suite 1000

Washington, D.C. 20006

Telephone: (202) 659-2930 Fax: (202) 887-0357

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

•	Full name of sole or first inventor (given name, family name) Katsuyuki Matsumoto					
(See note 'C above)	Inventor's Signature <u>Katsnyuki Matsumo to</u>	Date _	11/17	/2000		
,	Residence Hirakata - shi, Osaka, Japan	Citizenship _	Japanese			
	Post Office Address 5 - 25 - 46, Nagaomotomachi,	Hirakata – shi, (Osaka, Japan			
,						
	cond inventor (given name, family name)					
Inventor's Signa	ature	Date _				
Residence		Citizenship _				
Post Office Add	ress					
Full name of this	ird inventor (given name, family name)					
Inventor's Signa	ature	Date _				
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Post Office Add	ress					
Full name of fou	urth inventor (given name, family name)					
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Fall name of fift	th inventor (given name, family name)					
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Full name of sixt	th inventor (given name, family name)					
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	ress					
Full name of sev	venth inventor (given name, family name)					
	iture					
Residence		Citizenship				
Post Office Addr	ress	•				
Full name of eigl	thth inventor (given name, family name)					
Inventor's Signat	iture	Date				
Residence		Citizenship		,		
Post Office Addr	ress	1				